

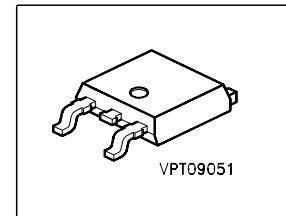
## Fast Switching EmCon Diode

### Product Summary

$V_{RRM}$	600	V
$I_F$	6	A
$V_F$	1.5	V
$T_{jmax}$	175	°C

### Feature

- 600 V EmCon technology
- Fast recovery
- Soft switching
- Low reverse recovery charge
- Low forward voltage
- 175°C operating temperature
- Easy paralleling
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC<sup>0)</sup> for target applications



Type	Package	Ordering Code	Marking	Pin 1	PIN 2,4	PIN 3
IDD06E60		-	D06E60	NC	C	A

**Maximum Ratings**, at  $T_j = 25$  °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	600	V
Continuous forward current $T_C = 25$ °C	$I_F$	14.7	A
$T_C = 90$ °C		10	
Surge non repetitive forward current $T_C = 25$ °C, $t_p = 10$ ms, sine halfwave	$I_{FSM}$	29	A
Maximum repetitive forward current $T_C = 25$ °C, $t_p$ limited by $t_{j,max}$ , $D = 0.5$	$I_{FRM}$	22	A
Power dissipation $T_C = 25$ °C	$P_{tot}$	46.8	W
$T_C = 90$ °C		26.6	
Operating junction temperature	$T_j$	-40...+175	
Storage temperature	$T_{stg}$	-55...+150	°C
Soldering temperature 1.6mm (0.063 in.) from case for 10 s	$T_s$	260	

**Thermal Characteristics**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Characteristics</b>					
Thermal resistance, junction - case	$R_{thJC}$	-	-	3.2	K/W
SMD version, device on PCB: @ min. footprint @ 6 cm <sup>2</sup> cooling area <sup>1)</sup>	$R_{thJA}$	-	-	75	
		-	-	50	

**Electrical Characteristics**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>Static Characteristics</b>					
Reverse leakage current $V_R=600\text{V}, T_j=25^\circ\text{C}$ $V_R=600\text{V}, T_j=150^\circ\text{C}$	$I_R$	-	-	50 500	$\mu\text{A}$
Forward voltage drop $I_F=6\text{A}, T_j=25^\circ\text{C}$ $I_F=6\text{A}, T_j=150^\circ\text{C}$	$V_F$	-	1.5 1.5	2 -	V

<sup>1)</sup>J-STD20 and JESD22

<sup>1)</sup>Device on 40mm\*40mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70  $\mu\text{m}$  thick) copper area for drain connection. PCB is vertical without blown air.

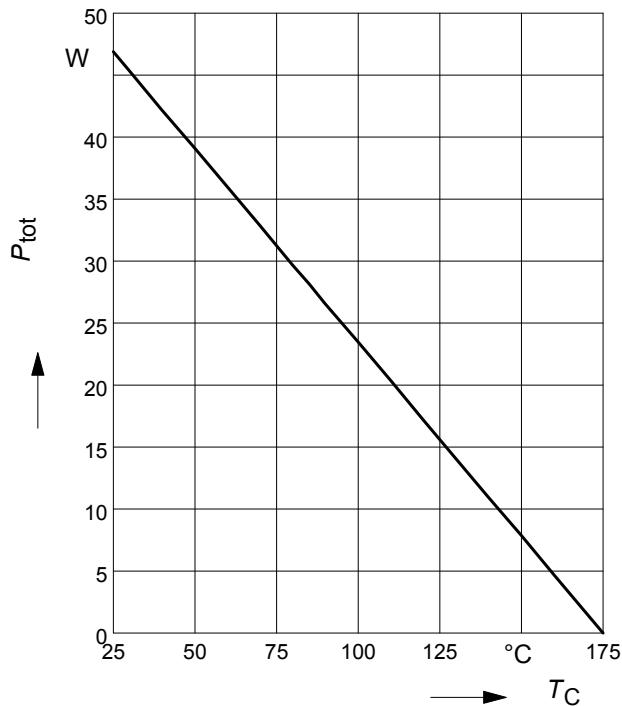
**Electrical Characteristics, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified**

<b>Parameter</b>	<b>Symbol</b>	<b>Values</b>			<b>Unit</b>
		<b>min.</b>	<b>typ.</b>	<b>max.</b>	
<b>Dynamic Characteristics</b>					
Reverse recovery time $V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=25^\circ\text{C}$	$t_{rr}$	-	70	-	ns
$V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		-	100	-	
$V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=150^\circ\text{C}$		-	105	-	
Peak reverse current $V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=25^\circ\text{C}$	$I_{rrm}$	-	6.5	-	A
$V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		-	7.4	-	
$V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=150^\circ\text{C}$		-	7.9	-	
Reverse recovery charge $V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=25^\circ\text{C}$	$Q_{rr}$	-	240	-	nC
$V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		-	360	-	
$V_R=400\text{V}, I_F=6\text{A}, di/dt=550\text{A}/\mu\text{s}, T_j=150^\circ\text{C}$		-	400	-	
Reverse recovery softness factor $V_R=400\text{V}, I_F=6\text{A}, di_F/dt=550\text{A}/\mu\text{s}, T_j=25^\circ\text{C}$	$S$	-	4	-	
$V_R=400\text{V}, I_F=6\text{A}, di_F/dt=550\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		-	4.8	-	
$V_R=400\text{V}, I_F=6\text{A}, di_F/dt=550\text{A}/\mu\text{s}, T_j=150^\circ\text{C}$		-	4.9	-	

### 1 Power dissipation

$$P_{\text{tot}} = f(T_C)$$

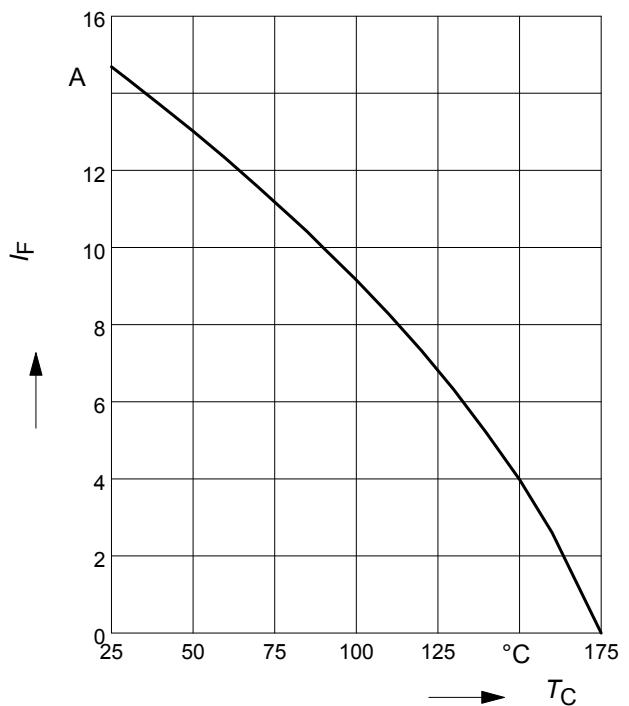
parameter:  $T_j \leq 175^\circ\text{C}$



### 2 Diode forward current

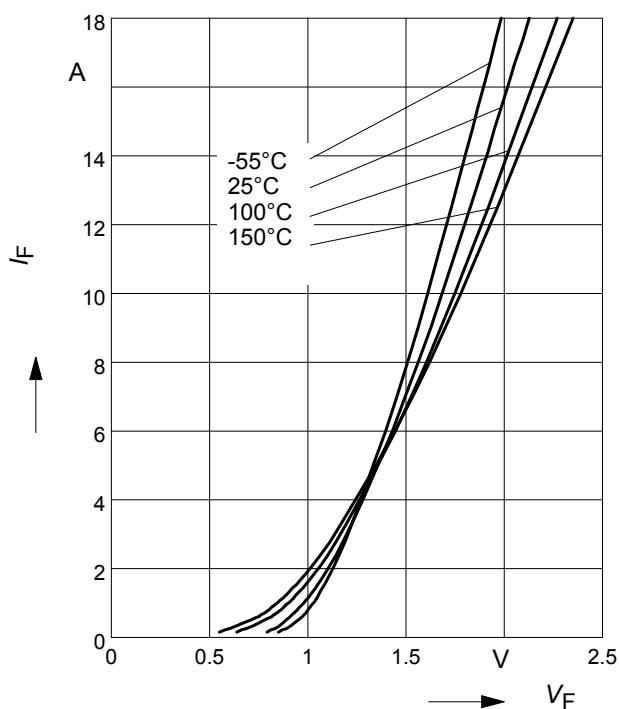
$$I_F = f(T_C)$$

parameter:  $T_j \leq 175^\circ\text{C}$



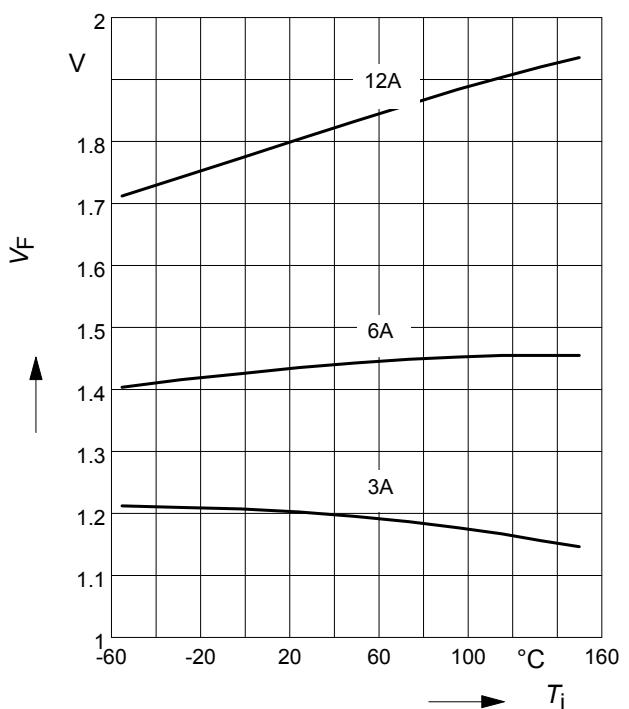
### 3 Typ. diode forward current

$$I_F = f(V_F)$$



### 4 Typ. diode forward voltage

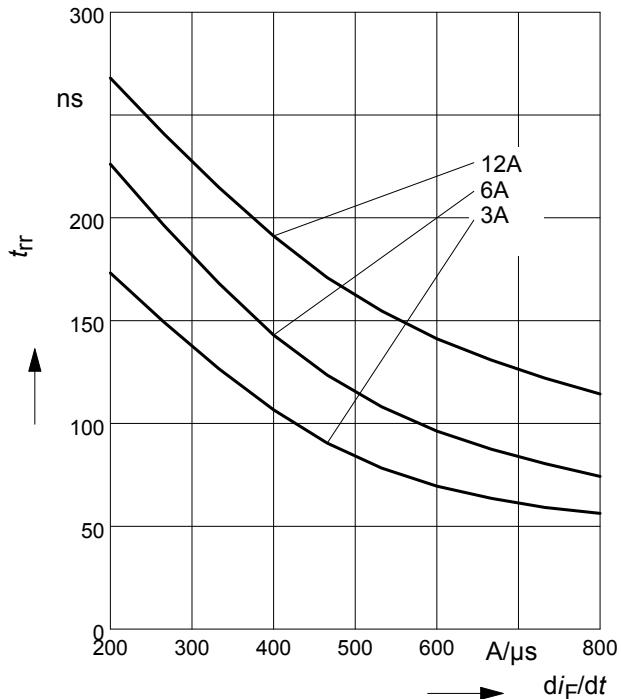
$$V_F = f(T_j)$$



### 5 Typ. reverse recovery time

$$t_{rr} = f(dI_F/dt)$$

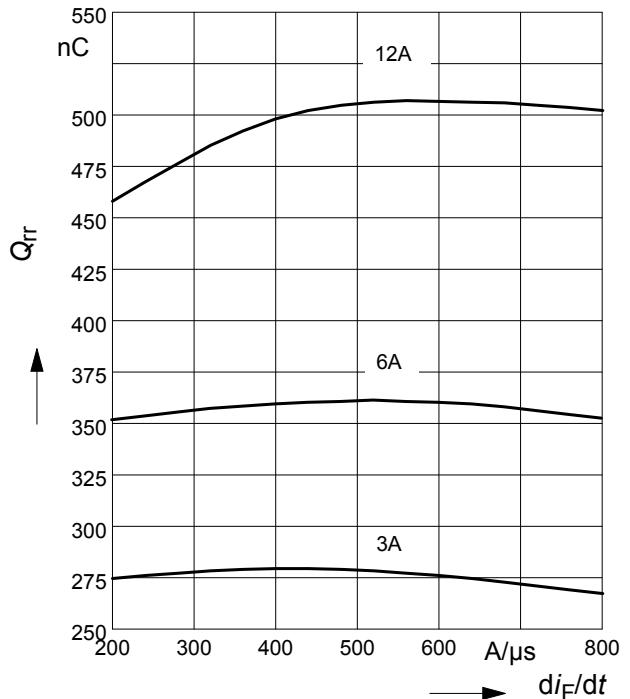
parameter:  $V_R = 400V$ ,  $T_j = 125^\circ C$



### 6 Typ. reverse recovery charge

$$Q_{rr} = f(dI_F/dt)$$

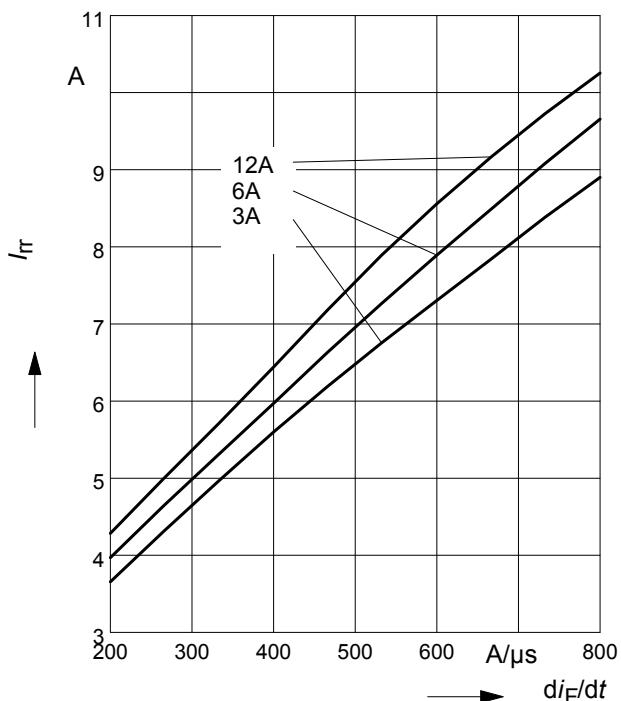
parameter:  $V_R = 400V$ ,  $T_j = 125^\circ C$



### 7 Typ. reverse recovery current

$$I_{rr} = f(dI_F/dt)$$

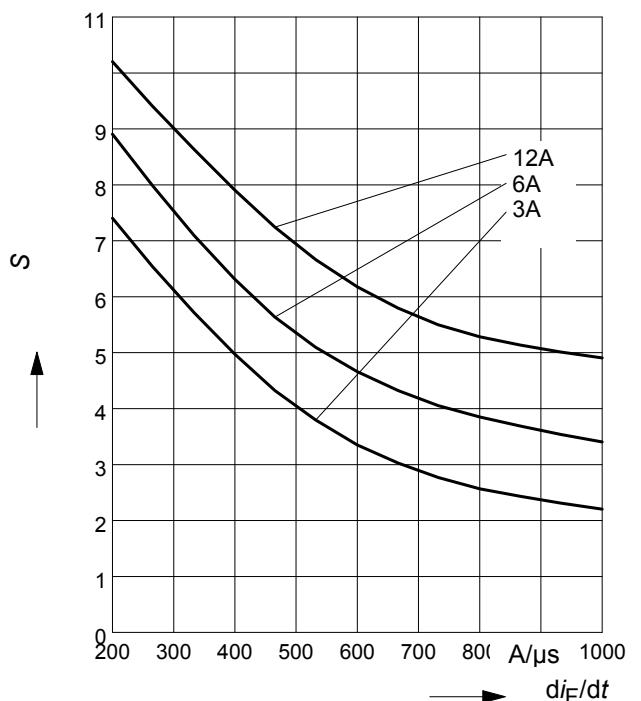
parameter:  $V_R = 400V$ ,  $T_j = 125^\circ C$



### 8 Typ. reverse recovery softness factor

$$S = f(dI_F/dt)$$

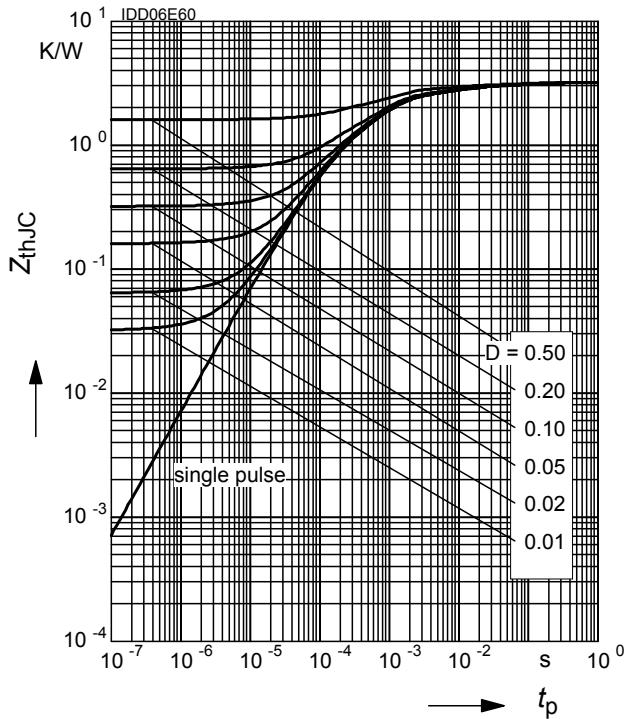
parameter:  $V_R = 400V$ ,  $T_j = 125^\circ C$

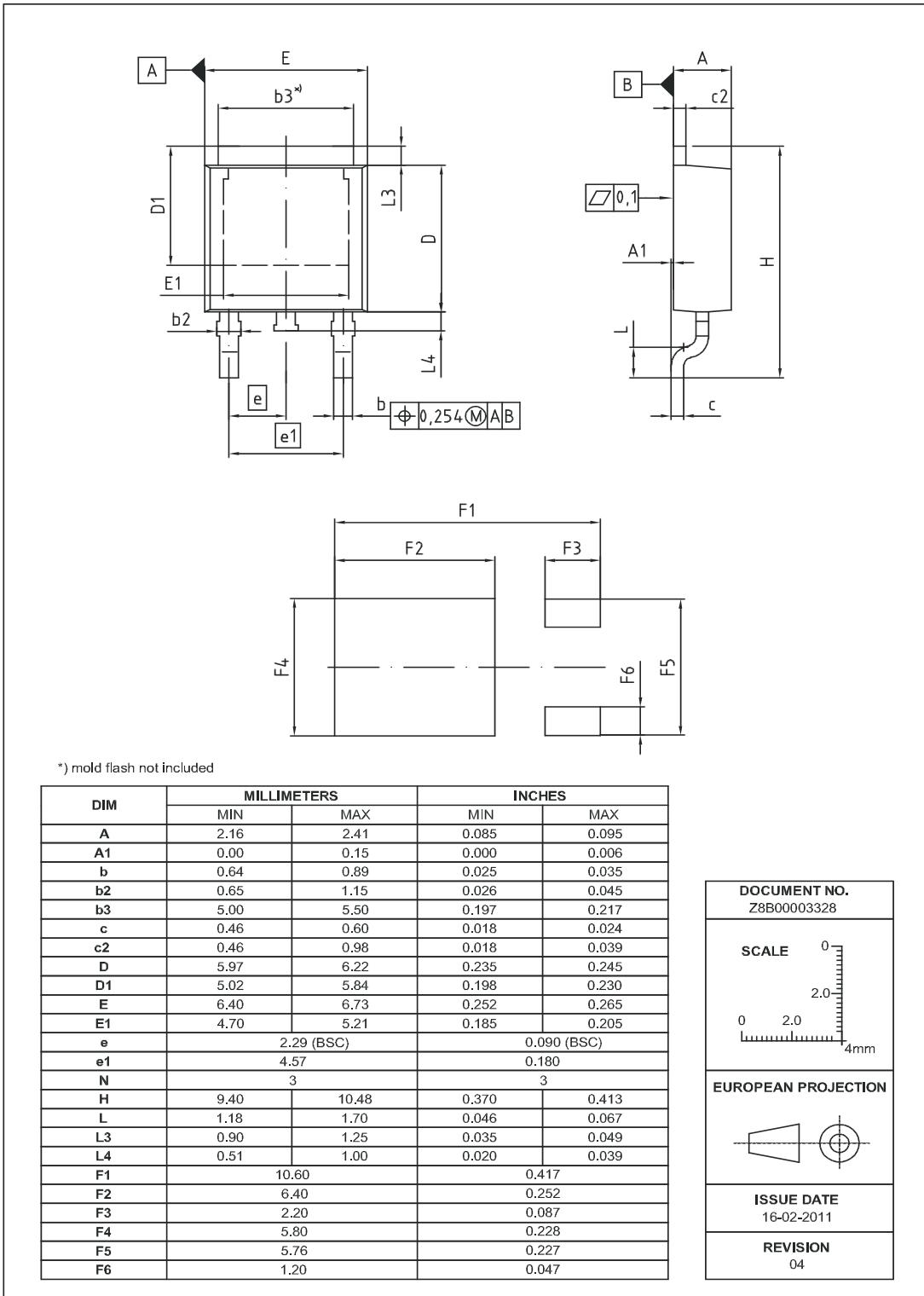


## 9 Max. transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

parameter :  $D = t_p/T$



**PG-T0252-3**


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**Infineon Technologies AG,**  
**Bereichs Kommunikation**  
**St.-Martin-Strasse 53,**  
**D-81541 München**  
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